



A Product Line of Diodes Incorporated



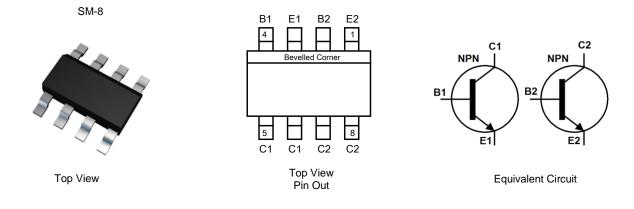
75V DUAL NPN HIGH GAIN MEDIUM POWER TRANSISTOR IN SM-8

Features

- BV_{CEO} > 75V
- I_c = 5A High Collector Current
- I_{CM} = 20A Peak Pulse Current
- High Gain h_{FE} > 300 @ 1A
- Low Saturation Voltage V_{CE(SAT)} < 150mV @ 1A
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SM-8 (8 LEAD SOT223)
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 ⁽²⁾
- Weight: 0.117 grams (Approximate)



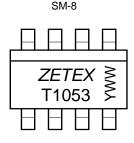
Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
ZDT1053TA	AEC-Q101	T1053	7	12	1,000

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



T1053 = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex: 5= 2015) WW or $\overline{W}W$ = Week Code (01 to 53)

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	NPN	Unit
Collector-Base Voltage	V _{CBO}	150	V
Collector-Emitter Voltage	V _{CEO}	75	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	Ic	5	А
Peak Pulse Current	I _{CM}	20	А
Base Current	IB	500	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Callector Dower Discinction	(Note 5)	P	2.25	W	
Collector Power Dissipation	(Note 6)	P _D	2.75		
Thermal Desistence, lumption to Ambient	(Note 5)	D	55.6	°CW	
Thermal Resistance, Junction to Ambient	(Note 6)	R _{0JA}	45.5	-C/W	
Thermal Resistance, Junction to Leads	(Note 7)	R _{θJL}	30.7	°C/W	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

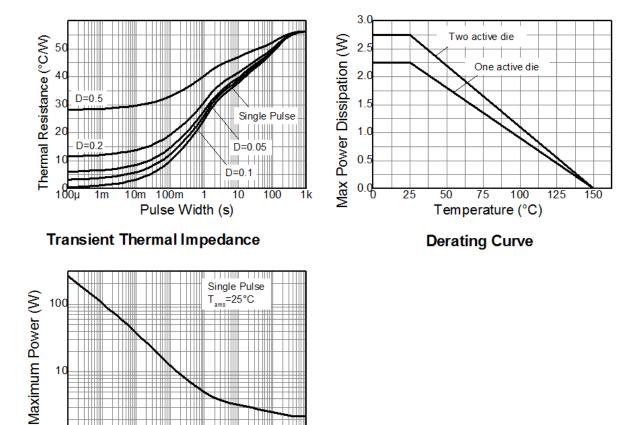
5. For a device with any single die active and mounted with the collector lead on 25mm x 25mm 2oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in steady-state. Notes:

6. Same as Note 5, except both die are active and equally sharing power.
7. Thermal resistance from junction to solder-point (at the end of the collector lead).
8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.





Thermal Characteristics and Derating Information



10

100µ

1m

10m

100m

Pulse Power Dissipation

Pulse Width (s)

10

100

1k





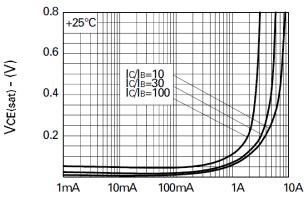
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	150	245	—	V	I _C = 100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	75	100	—	V	I _C = 10mA
Collector-Emitter Breakdown Voltage	BV _{CES}	150	245	—	V	I _C = 100μA
Collector-Emitter Breakdown Voltage	BV _{CEV}	150	245	—	V	$I_C = 100 \mu A$, $V_{EB} = 1 V$
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.8	—	V	I _E = 100μA
Collector Cut-Off Current	I _{CBO}	_	<1	10	nA	V _{CB} = 120V
Emitter Cut-Off Current	I _{EBO}	_	<1	10	nA	V _{EB} = 5.6V
Collector Emitter Cut-Off Current	ICES	_	<1	10	nA	V _{CES} = 120V
		260	420	_		$\label{eq:linear} \begin{split} I_{C} &= 10 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 1 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 2 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 5 \text{A}, \ V_{CE} = 2 \text{V} \end{split}$
		300	450	1200		
DC Current Transfer Static Ratio (Note 9)	h _{FE}	150	220	_		
		30	50	_		
		—	15	—		$I_{C} = 10A, V_{CE} = 2V$
	V _{CE(sat)}	—	17	25	mV	$\begin{split} & I_{C} = 0.2A, \ I_{B} = 20 mA \\ & I_{C} = 1A, \ I_{B} = 50 mA \\ & I_{C} = 1A, \ I_{B} = 10 mA \\ & I_{C} = 2A, \ I_{B} = 50 mA \\ & I_{C} = 5A, \ I_{B} = 250 mA \end{split}$
		—	70	100		
Collector-Emitter Saturation Voltage (Note 9)		—	120	150		
		_	150	200		
		—	300	440		
Base-Emitter Saturation Voltage (Note 9)	V _{BE(SAT)}	—	1100	1200	mV	$I_{C} = 5A, I_{B} = 250mA$
Base-Emitter Turn-On Voltage (Note 9)	V _{BE(ON)}	—	1000	1100	mV	$I_{C} = 5A, V_{CE} = 2V$
Transitional Frequency	f⊤	_	140	_	MHz	$I_C = 50 \text{mA}, V_{CE} = 10 \text{V},$ f = 100MHz
Output Capacitance	C _{OBO}	_	21	30	pF	V _{EB} = 10V, f = 1MHz
Quitching Time	t _{ON}		90		ns	$V_{CC} = 50V, I_C = 2A,$
Switching Time	tOFF		750	1 —	ns	$I_{B1} = -I_{B2} = 20 \text{mA}$

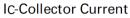
Note: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



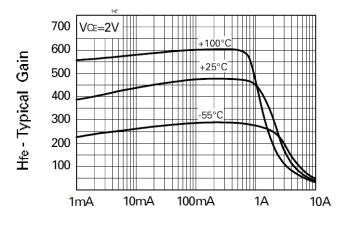


Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



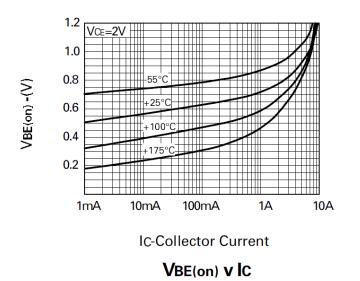


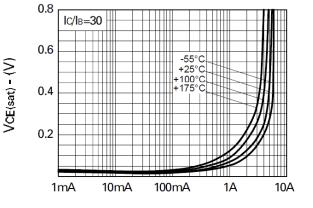




IC-Collector Current

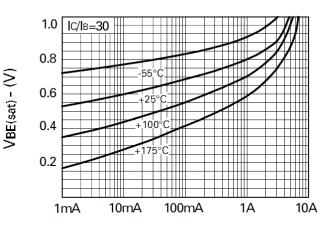
hfe v IC







VCE(sat) v IC



IC-Collector Current

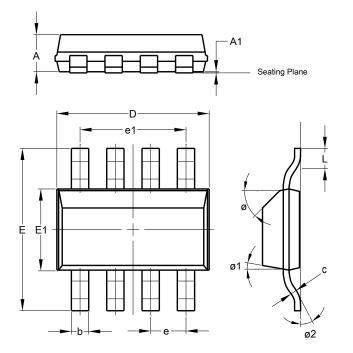
VBE(sat) v lc





Package Outline Dimensions

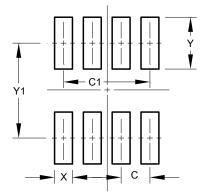
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SM-8						
Dim	Min Max Typ					
Α		1.70	1.60			
A1	0.02	0.10	0.04			
b	0.70	0.90	0.80			
C	0.24	0.32	0.28			
D	6.30	6.70	6.60			
e	1.53 REF					
e1	4.59 REF					
Е	6.70	7.30	7.00			
E1	3.30	3.70	3.50			
L	0.75	1.00	0.90			
Ø	45°					
Ø1		15°				
Ø2			10°			
All I	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.52
C1	4.60
Х	0.95
Y	2.80
Y1	6.80





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